2SD655

DATA SHEET

/ Descriptions

TO-92 NPN

/ Features

/ Applications

/ Equivalent Circuit

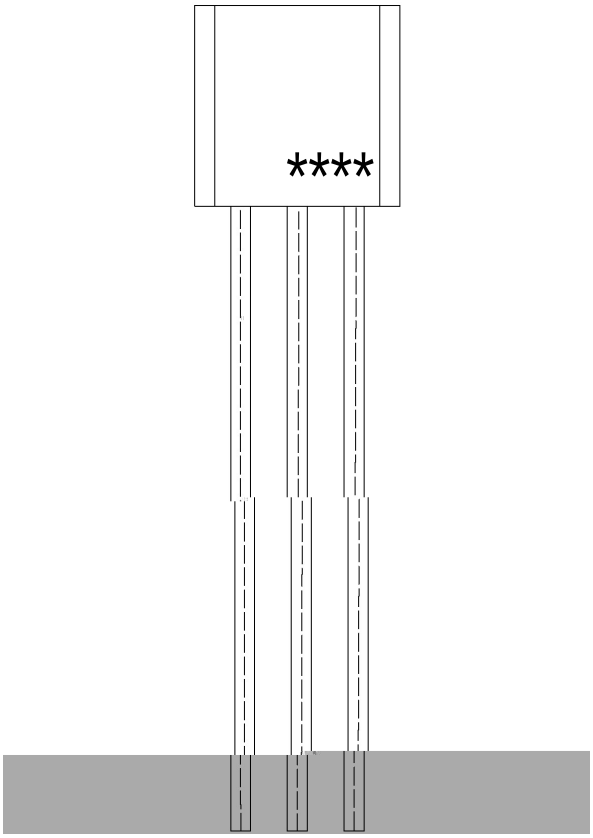
/ Pinning



/ hFE Classifications & Marking

2SD655

/ Marking Instructions



BR:

D655

D: h_{FE}

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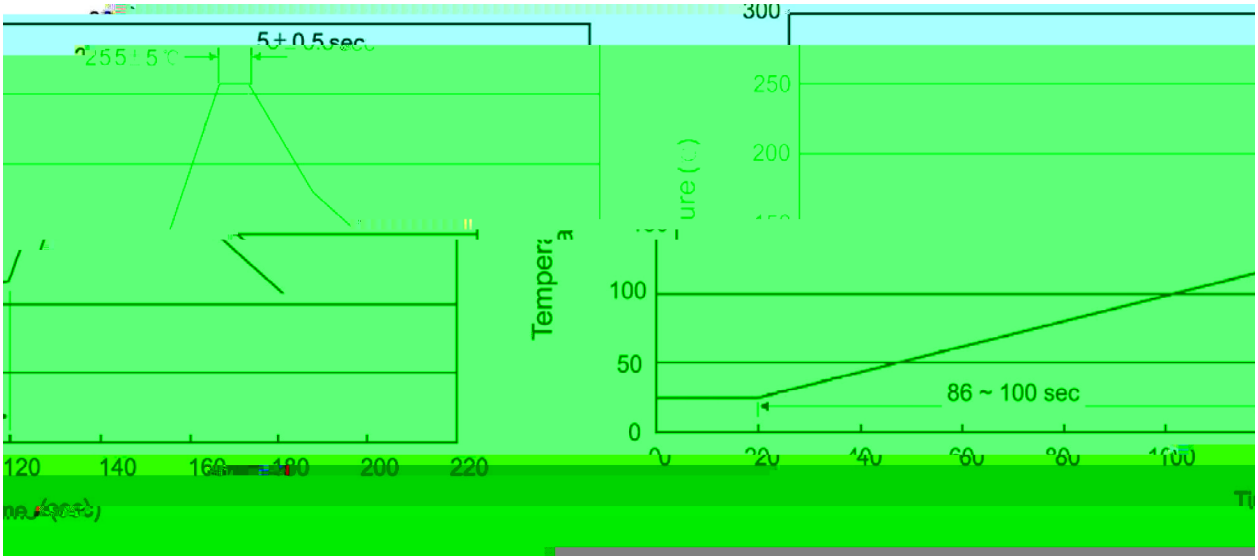
( ) / Temperature Profile for Dip Soldering(Pb-Free)



± ± ± ±

/ Resistance to Soldering Heat Test Conditions

± ±

/ Packaging SPEC.

封装形式	包装数量					包装尺寸 :		
	Units/Bag 只/袋	Bags/Inner Box 袋/盒	Units/Inner Box 只/盒	Inner Boxes/Outer Box 盒/箱	Units/Outer Box 只/箱	Bag 袋	Inner Box 盒	Outer Box 箱
TO-92	1,000	10	10,000	5	50,000	135×190	237×172×102	560×245×195
	1,000	10	Bag6	re10	T8(600023	T(Bag)14(10,590)75(	)13384(237×172×79(102)75(	)9173(560×245